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PATENT APPLICATION

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IN THE U.S. PATENT AND TRADEMARK OFFICE

February 3, 2006

Applicant : Chisato HOSHINO
For : THERMAL CONDUCTIVE SILICONE COMPOSITION

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Mail Stop PCT
Commissioner for Patents
P.O. Box 1450
Alexandria, VA 22313-1450

PRELIMINARY AMENDMENT CANCELING CLAIMS

Sir:

Prior to calculation of the filing fee in the above-identified application, kindly enter the following:

(Please see following pages.)